ABSTRACT

SEMICONDUCTOR DEVICE AND TAPE CARRIER, AND METHOD OF MANUFACTURING THE SAME, CIRCUIT BOARD, ELECTRONIC INSTRUMENT, AND TAPE CARRIER MANUFACTURING DEVICE

A method of manufacturing a tape carrier comprises: a step of providing a tape carrier having bonding portions formed in rows in the width direction, repeating in the longitudinal direction, and having identification marks delimiting regularly repeating matrices formed of pluralities of rows and columns of the bonding portions; a step of examining the tape carrier; a step of removing a defective location of the tape carrier detected in the examination step, and joining together the separated tape carrier to preserve the regular repetition of the matrix; and a step of forming a join mark for delimiting a matrix in which the join formed in the joining step is positioned.

FIG. 6